# ne<mark>x</mark>peria

#### Important notice

Dear Customer,

On 7 February 2017 the former NXP Standard Product business became a new company with the tradename **Nexperia**. Nexperia is an industry leading supplier of Discrete, Logic and PowerMOS semiconductors with its focus on the automotive, industrial, computing, consumer and wearable application markets

In data sheets and application notes which still contain NXP or Philips Semiconductors references, use the references to Nexperia, as shown below.

Instead of <u>http://www.nxp.com</u>, <u>http://www.philips.com/</u> or <u>http://www.semiconductors.philips.com/</u>, use <u>http://www.nexperia.com</u>

Instead of sales.addresses@www.nxp.com or sales.addresses@www.semiconductors.philips.com, use **salesaddresses@nexperia.com** (email)

Replace the copyright notice at the bottom of each page or elsewhere in the document, depending on the version, as shown below:

- © NXP N.V. (year). All rights reserved or © Koninklijke Philips Electronics N.V. (year). All rights reserved

Should be replaced with:

- © Nexperia B.V. (year). All rights reserved.

If you have any questions related to the data sheet, please contact our nearest sales office via e-mail or telephone (details via **salesaddresses@nexperia.com**). Thank you for your cooperation and understanding,

Kind regards,

Team Nexperia

# 10-bit level-shifting bus switch with output enableRev. 4 — 14 December 2011Prode

Product data sheet

#### **General description** 1.

The 74CBTLVD3861 is a 10-bit 3.3 V to 1.8 V level translating bus switch with one output enable ( $\overline{OE}$ ) input. When  $\overline{OE}$  is LOW, the switch is closed and port A is connected to the B port. When OE is HIGH, the switch is disabled.

To ensure the high-impedance OFF-state during power-up or power-down, OE should be tied to the V<sub>CC</sub> through a pull-up resistor. The minimum value of the resistor is determined by the current-sinking capability of the driver.

Schmitt trigger action at control input makes the circuit tolerant to slower input rise and fall times across the entire  $V_{CC}$  range from 3.0 V to 3.6 V.

This device is fully specified for partial power-down applications using I<sub>OFF</sub>.

#### **Features and benefits** 2.

- Supply voltage range from 3.0 V to 3.6 V
- High noise immunity
- Complies with JEDEC standard:
  - ◆ JESD8-B/JESD36 (3.0 V to 3.6 V)
- ESD protection:
  - HBM JESD22-A114F exceeds 2000 V
  - CDM AEC-Q100-011 revision B exceeds 1000 V
- 4 Ω switch connection between two ports
- 3.3 V to 1.8 V level translation
- CMOS low power consumption
- Latch-up performance exceeds 250 mA per JESD78B Class I level A
- IOFF circuitry provides partial Power-down mode operation
- Multiple package options
- Specified from -40 °C to +85 °C and -40 °C to +125 °C



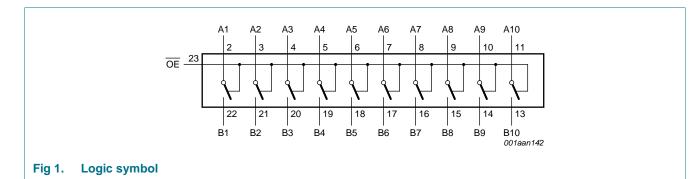
10-bit level-shifting bus switch with output enable

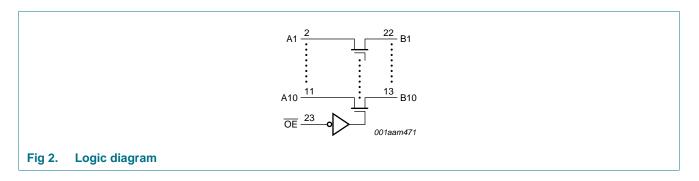
# 3. Ordering information

Table 1. Ordering	information			
Type number	Package			
	Temperature range	Name	Description	Version
74CBTLVD3861DK	–40 °C to +125 °C	SSOP24 <sup>[1]</sup>	plastic shrink small outline package; 24 leads; body width 3.9 mm; lead pitch 0.635 mm	SOT556-1
74CBTLVD3861PW	–40 °C to +125 °C	TSSOP24	plastic thin shrink small outline package; 24 leads; body width 4.4 mm	SOT355-1
74CBTLVD3861BQ	–40 °C to +125 °C	DHVQFN24	plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 24 terminals; body $3.5 \times 5.5 \times 0.85$ mm	SOT815-1

[1] Also known as QSOP24 package

# 4. Functional diagram

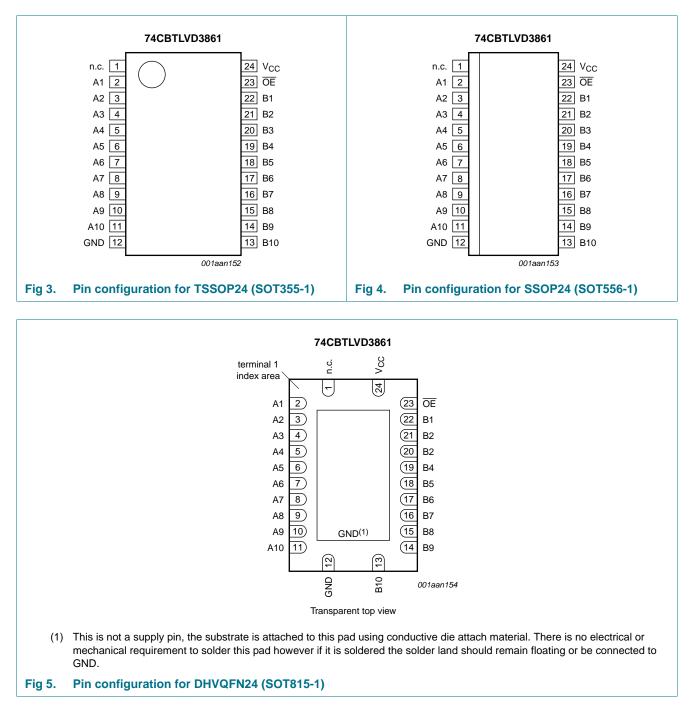




10-bit level-shifting bus switch with output enable

### 5. Pinning information

### 5.1 Pinning



10-bit level-shifting bus switch with output enable

### 5.2 Pin description

Table 2.	Pin description	
Symbol	Pin	Description
nc	1	not connected
A1 to A10	2, 3, 4, 5, 6, 7, 8, 9, 10,	11 data input/output (A port)
GND	12	ground (0 V)
B1 to B10	22, 21, 20, 19, 18, 17, 1	6, 15, 14, 13 data input/output (B port)
OE	23	output enable input (active LOW)
V <sub>CC</sub>	24	positive supply voltage

### 6. Functional description

#### Table 3. Function selection<sup>[1]</sup>

Input OE	Input/output
ŌĒ	An, Bn
L	An = Bn
Н	Z

[1] H = HIGH voltage level; L = LOW voltage level; Z = high-impedance OFF-state.

### 7. Limiting values

#### Table 4.Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
V <sub>CC</sub>	supply voltage		-0.5	+4.6	V
VI	input voltage		<u>[1]</u> –0.5	+4.6	V
V <sub>SW</sub>	switch voltage	enable and disable mode	<u>[1]</u> –0.5	V <sub>CC</sub> + 0.5	V
I <sub>IK</sub>	input clamping current	$V_{I} < -0.5 V$	-50	-	mA
I <sub>SK</sub>	switch clamping current	$V_{I} < -0.5 V$	-50	-	mA
I <sub>SW</sub>	switch current	$V_{SW} = 0 V$ to $V_{CC}$	-	±128	mA
I <sub>CC</sub>	supply current		-	+100	mA
I <sub>GND</sub>	ground current		-100	-	mA
T <sub>stg</sub>	storage temperature		-65	+150	°C
P <sub>tot</sub>	total power dissipation	$T_{amb} = -40 \text{ °C to } +125 \text{ °C}$	[2] _	500	mW

[1] The minimum input and output voltage ratings may be exceeded if the input and output current ratings are observed.

For SSOP24 and TSSOP24 packages: P<sub>tot</sub> derates linearly with 5.5 mW/K above 60 °C.
 For DHVQFN24 package: P<sub>tot</sub> derates linearly at 4.5 mW/K above 60 °C.

# 74CBTLVD3861

10-bit level-shifting bus switch with output enable

### 8. Recommended operating conditions

Table 5.	Recommended operating conditi	ons			
Symbol	Parameter	Conditions	Min	Max	Unit
V <sub>CC</sub>	supply voltage		3.0	3.6	V
VI	input voltage		0	3.6	V
V <sub>SW</sub>	switch voltage	enable and disable mode	0	V <sub>CC</sub>	V
T <sub>amb</sub>	ambient temperature		-40	+125	°C
$\Delta t / \Delta V$	input transition rise and fall rate	$V_{CC}$ = 3.0 V to 3.6 V	<u>[1]</u> _	200	ns/V

[1] Applies to control signal levels.

### 9. Static characteristics

#### Table 6. Static characteristics

At recommended operating conditions voltages are referenced to GND (ground = 0 V).

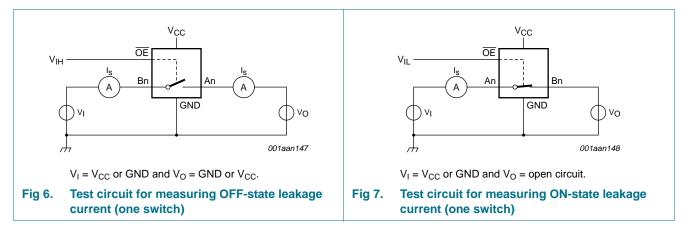
Symbol	Parameter	Conditions	Tar	nb = -	–40 °C to ·	+85 °C	T <sub>amb</sub> = -40 °C	C to +125 °C	Unit
			М	in	Typ <mark>[1]</mark>	Max	Min	Max	
V <sub>IH</sub>	HIGH-level input voltage	$V_{CC} = 3.0 V \text{ to } 3.6 V$	2	.0	-	-	2.0	-	V
V <sub>IL</sub>	LOW-level input voltage	$V_{CC}$ = 3.0 V to 3.6 V	,	-	-	0.9	-	0.9	V
l <sub>l</sub>	input leakage current	pin $\overline{OE}$ ; V <sub>I</sub> = GND to V <sub>CC</sub> ; V <sub>CC</sub> = 3.6 V	,	-	-	±1	-	±20	μA
V <sub>pass</sub>	pass voltage	$V_I = V_{CC}$ ; see <u>Figure 8</u> to <u>Figure 12</u>		-	-	-	-	-	V
$I_{S(OFF)}$	OFF-state leakage current	$V_{CC} = 3.6 V$ ; see <u>Figure 6</u>		-	-	±1	-	±20	μA
I <sub>S(ON)</sub>	ON-state leakage current	$V_{CC} = 3.6 V$ ; see <u>Figure 7</u>		-	-	±1	-	±20	μA
I <sub>OFF</sub>	power-off leakage current	$V_1 \text{ or } V_0 = 0 \text{ V to } 3.6 \text{ V};$ $V_{CC} = 0 \text{ V}$		-	-	±10	-	±50	μA
I <sub>CC</sub>	supply current	$\label{eq:VI} \begin{array}{l} V_{I} = V_{CC}; \ I_{O} = 0 \ A; \ V_{CC} = 3.6 \ V; \\ V_{SW} = GND \ or \ V_{CC} \end{array}$	,	-	-	20	-	50	μA
		$V_{I} = \text{GND}; I_{O} = 0 \text{ A};$ $V_{CC} = 3.6 \text{ V};$ $V_{SW} = \text{GND or } V_{CC}$	,	-	-	100	-	150	μΑ
Δl <sub>CC</sub>	additional supply current	pin $\overline{OE}$ ; V <sub>1</sub> = V <sub>CC</sub> - 0.6 V; V <sub>SW</sub> = GND or V <sub>CC</sub> ; V <sub>CC</sub> = 3.6 V	[2]	-	-	300	-	2000	μA
Cı	input capacitance	pin $\overline{OE}$ ; V <sub>CC</sub> = 3.3 V; V <sub>I</sub> = 0 V to 3.3 V	,	-	0.9	-	-	-	pF
$C_{S(OFF)}$	OFF-state capacitance	$V_{CC}$ = 3.3 V; $V_{I}$ = 0 V to 3.3 V	,	-	2.5	-	-	-	pF
C <sub>S(ON)</sub>	ON-state capacitance	$V_{CC}$ = 3.3 V; $V_{I}$ = 0 V to 3.3 V	,	-	9.0	-	-	-	pF

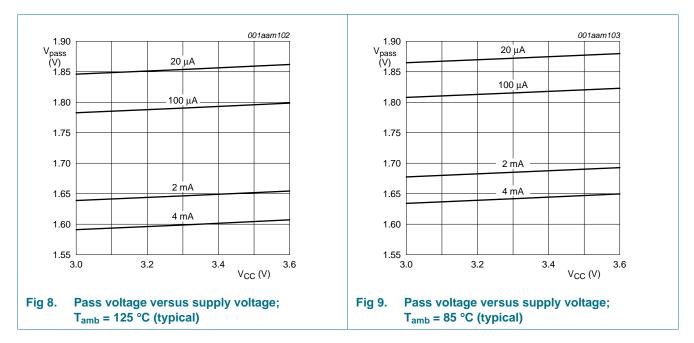
[1] All typical values are measured at  $T_{amb}$  = 25 °C.

[2] One input at 3 V, other inputs at  $V_{CC}$  or GND.

10-bit level-shifting bus switch with output enable

### 9.1 Test circuits

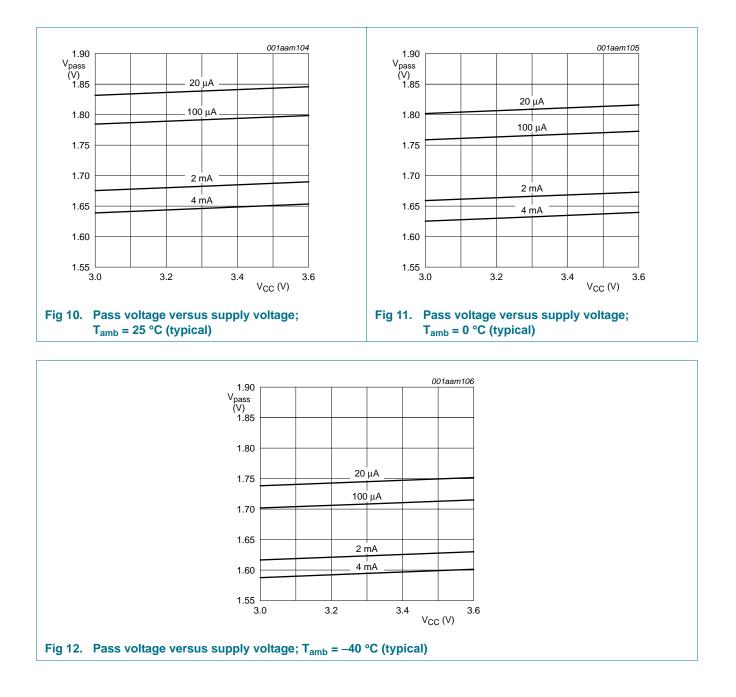




### 9.2 Typical pass voltage graphs

# 74CBTLVD3861

10-bit level-shifting bus switch with output enable



#### 10-bit level-shifting bus switch with output enable

#### 9.3 ON resistance

#### Table 7. Resistance R<sub>ON</sub>

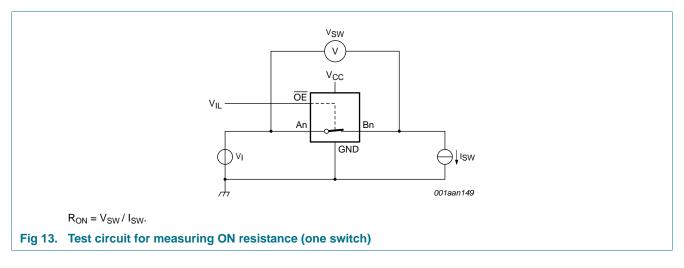
At recommended operating conditions; voltages are referenced to GND (ground = 0 V); for test circuit see Figure 13.

Symbol	mbol Parameter Conditions		T <sub>amb</sub> =	–40 °C to	+85 °C	T <sub>amb</sub> = -40 °	Unit	
			Min	Typ <mark>[1]</mark>	Max	Min	Max	
R <sub>ON</sub>	ON resistance	$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$ [2]						
		$I_{SW} = 64 \text{ mA}; V_I = 0 \text{ V}$	-	3.7	7.0	-	10.0	Ω
		$I_{SW} = 24 \text{ mA}; V_I = 0 \text{ V}$	-	3.7	7.0	-	10.0	Ω
		$I_{SW}$ = 15 mA; $V_{I}$ = 1.2 V	-	4.7	10.0	-	12.0	Ω

[1] Typical values are measured at  $T_{amb}$  = 25 °C and nominal  $V_{CC}.$ 

[2] Measured by the voltage drop between the An and Bn terminals at the indicated current through the switch. ON-state resistance is determined by the lower of the voltages of the two (An or Bn) terminals.

## 9.4 ON resistance test circuit



#### 10-bit level-shifting bus switch with output enable

### **10.** Dynamic characteristics

#### Table 8. Dynamic characteristics

GND = 0 V; for test circuit see Figure 16

Symbol	Parameter	Conditions		$T_{amb} = -40 \ ^{\circ}C \ to \ +85 \ ^{\circ}C$			T <sub>amb</sub> = -40 °	C to +125 °C	Unit
				Min	Typ <mark>[1]</mark>	Max	Min	Мах	
t <sub>pd</sub>	propagation delay	An to Bn or Bn to An; see <u>Figure 14</u>	<u>[2][3]</u>						
		$V_{CC}$ = 3.0 V to 3.6 V		-	-	0.11	-	0.22	ns
t <sub>en</sub>	enable time	OE to An or Bn; see <u>Figure 15</u>	<u>[4]</u>						
		$V_{CC}$ = 3.0 V to 3.6 V		1.5	2.9	5.0	1.5	6.0	ns
t <sub>dis</sub> disable time		OE to An or Bn; see <u>Figure 15</u>	<u>[5]</u>						
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$		0.8	3.3	7.0	0.8	8.0	ns

[1] All typical values are measured at  $T_{amb}$  = 25 °C and at nominal V<sub>CC</sub>.

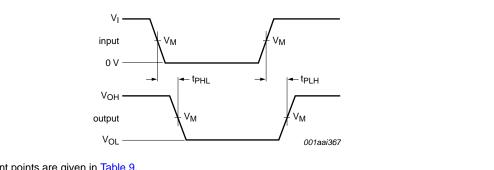
[2] The propagation delay is the calculated RC time constant of the on-state resistance of the switch and the load capacitance, when driven by an ideal voltage source (zero output impedance).

[3]  $t_{pd}$  is the same as  $t_{PLH}$  and  $t_{PHL}$ .

[4]  $t_{en}$  is the same as  $t_{PZH}$  and  $t_{PZL}$ .

[5]  $t_{dis}$  is the same as  $t_{PHZ}$  and  $t_{PLZ}$ .

### 10.1 Waveforms



Measurement points are given in Table 9.

Logic levels:  $V_{\text{OL}}$  and  $V_{\text{OH}}$  are typical output voltage levels that occur with the output load.

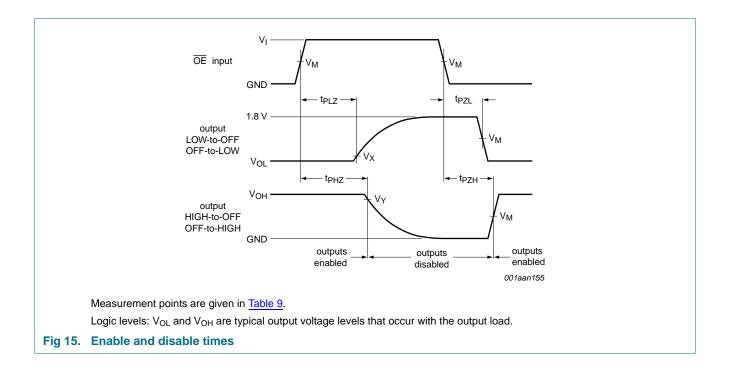
Fig 14. The data input (An, Bn) to output (Bn, An) propagation delay times

#### Table 9. Measurement points

Supply voltage	Input			Output		
V <sub>cc</sub>	V <sub>M</sub>	VI	$t_r = t_f$	V <sub>M</sub>	V <sub>X</sub>	V <sub>Y</sub>
3.0 V to 3.6 V	0.5V <sub>CC</sub>	V <sub>CC</sub>	$\leq$ 2.0 ns	0.9 V	V <sub>OL</sub> + 0.15 V	$V_{OH} - 0.15 \ V$

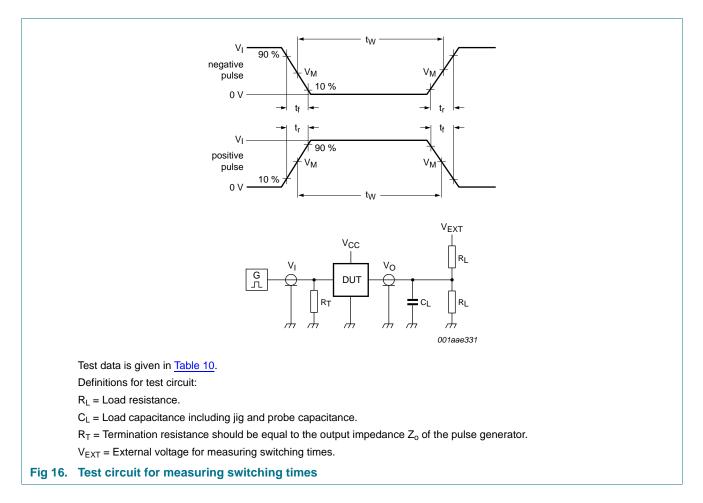
# 74CBTLVD3861

10-bit level-shifting bus switch with output enable



# 74CBTLVD3861

#### 10-bit level-shifting bus switch with output enable



#### Table 10. Test data

Supply voltage	Load V <sub>1</sub>		V <sub>EXT</sub>		
V <sub>cc</sub>	CL	R <sub>L</sub>	t <sub>PLH</sub> , t <sub>PHL</sub>	t <sub>PZH</sub> , t <sub>PHZ</sub>	t <sub>PZL</sub> , t <sub>PLZ</sub>
3.0 V to 3.6 V	30 pF	1 kΩ	open	GND	3.6 V

10-bit level-shifting bus switch with output enable

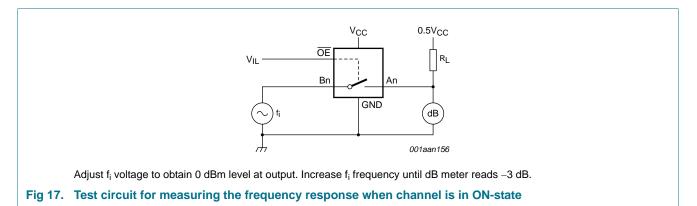
### **10.2** Additional dynamic characteristics

Table 11.Additional dynamic characteristicsGND = 0 V.

Symbol	Parameter	Conditions		T <sub>ar</sub>	Unit		
				Min	Тур	Max	
$f_{(-3dB)}$	-3 dB frequency response	$V_{CC}$ = 3.3 V; $R_L$ = 50 $\Omega$ ; see Figure 17	<u>[1]</u>	-	575	-	MHz

[1]  $f_i$  is biased at 0.5V<sub>CC</sub>.

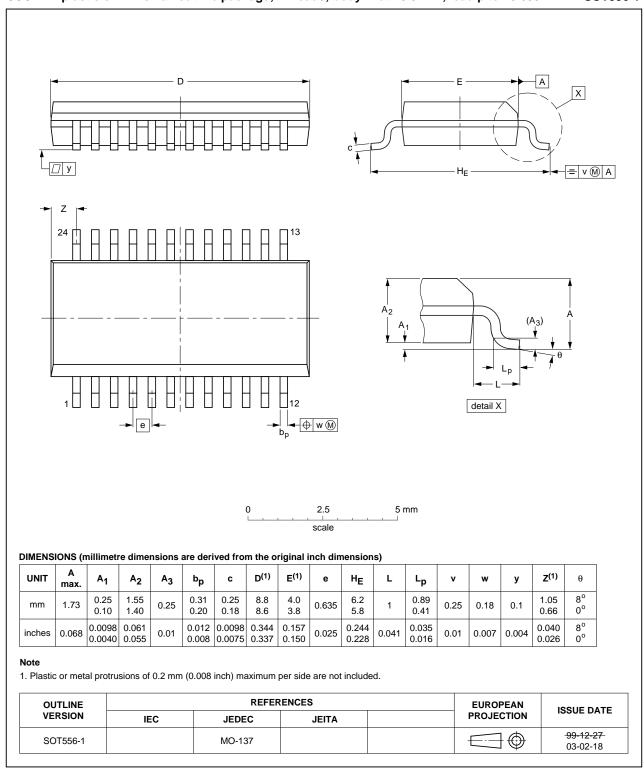
### 10.3 Test circuit



# 74CBTLVD3861

10-bit level-shifting bus switch with output enable

### 11. Package outline

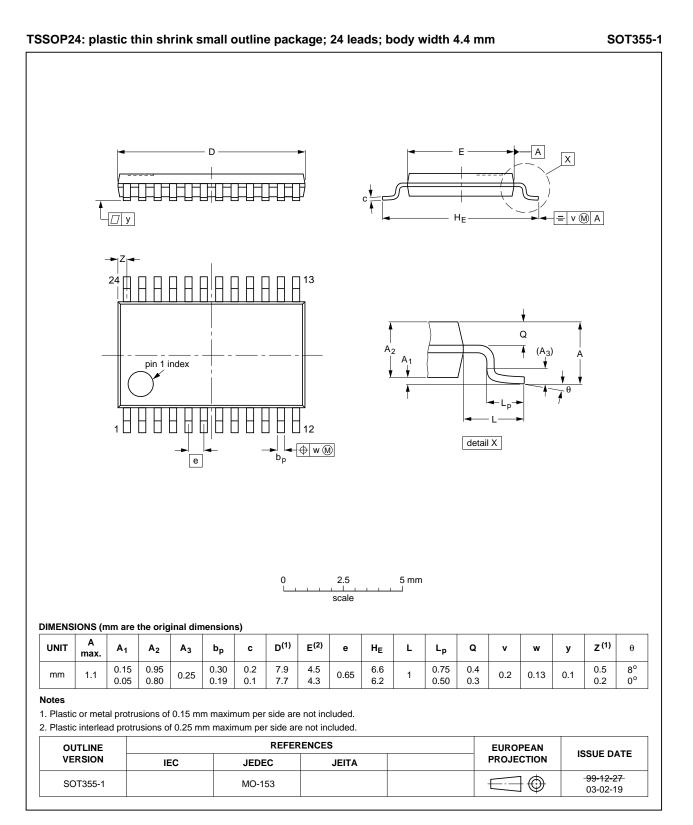


#### SSOP24: plastic shrink small outline package; 24 leads; body width 3.9 mm; lead pitch 0.635 mm SOT556-1

Fig 18. Package outline SOT556-1 (SSOP24)

All information provided in this document is subject to legal disclaimers.

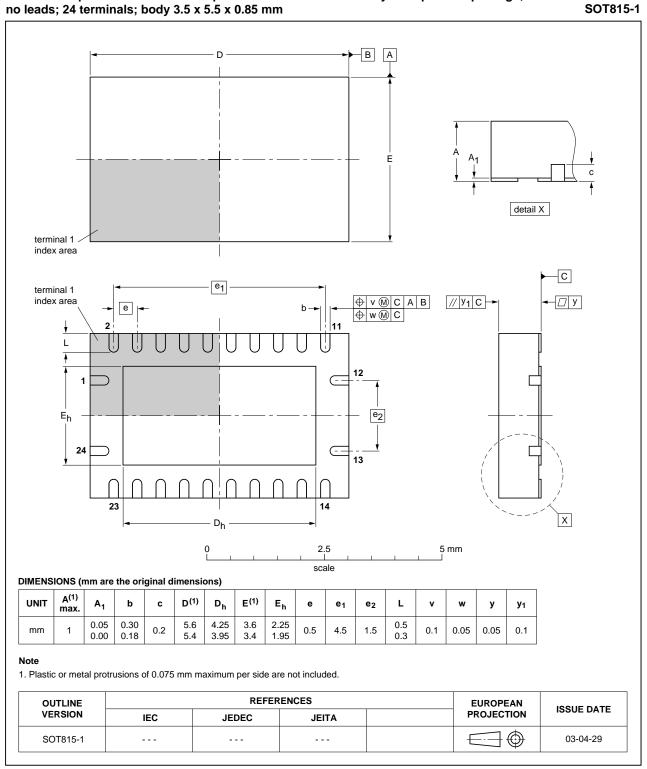
10-bit level-shifting bus switch with output enable



#### Fig 19. Package outline SOT355-1 (TSSOP24)

All information provided in this document is subject to legal disclaimers.

10-bit level-shifting bus switch with output enable



#### DHVQFN24: plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 24 terminals; body 3.5 x 5.5 x 0.85 mm

#### Fig 20. Package outline SOT815-1 (DHVQFN24)

All information provided in this document is subject to legal disclaimers.

10-bit level-shifting bus switch with output enable

# **12. Abbreviations**

Table 12. Abbr	reviations
Acronym	Description
CDM	Charged Device Model
CMOS	Complementary Metal-Oxide Semiconductor
DUT	Device Under Test
ESD	ElectroStatic Discharge
НВМ	Human Body Model

# **13. Revision history**

#### Table 13.Revision history

Delesse dete			
Release date	Data sheet status	Change notice	Supersedes
20111214	Product data sheet	-	74CBTLVD3861 v.3
Legal pages	updated.		
20111020	Product data sheet	-	74CBTLVD3861 v.2
20110117	Product data sheet	-	74CBTLVD3861 v.1
20101206	Product data sheet	-	-
	<ul> <li>Legal pages</li> <li>20111020</li> <li>20110117</li> </ul>	<ul> <li>Legal pages updated.</li> <li>20111020 Product data sheet</li> <li>20110117 Product data sheet</li> </ul>	20111214Product data sheet-• Legal pages updated20111020Product data sheet-20110117Product data sheet-

10-bit level-shifting bus switch with output enable

### 14. Legal information

#### 14.1 Data sheet status

Document status[1][2]	Product status <sup>[3]</sup>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions"

The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status [3] information is available on the Internet at URL http://www.nxp.com.

#### 14.2 Definitions

Draft — The document is a draft version only. The content is still under internal review and subject to formal approval, which may result in modifications or additions. NXP Semiconductors does not give any representations or warranties as to the accuracy or completeness of information included herein and shall have no liability for the consequences of use of such information.

Short data sheet — A short data sheet is an extract from a full data sheet with the same product type number(s) and title. A short data sheet is intended for guick reference only and should not be relied upon to contain detailed and full information. For detailed and full information see the relevant full data sheet, which is available on request via the local NXP Semiconductors sales office. In case of any inconsistency or conflict with the short data sheet, the full data sheet shall prevail.

Product specification - The information and data provided in a Product data sheet shall define the specification of the product as agreed between NXP Semiconductors and its customer. unless NXP Semiconductors and customer have explicitly agreed otherwise in writing. In no event however, shall an agreement be valid in which the NXP Semiconductors product is deemed to offer functions and qualities beyond those described in the Product data sheet.

#### 14.3 **Disclaimers**

Limited warranty and liability - Information in this document is believed to be accurate and reliable. However, NXP Semiconductors does not give any representations or warranties, expressed or implied, as to the accuracy or completeness of such information and shall have no liability for the consequences of use of such information.

In no event shall NXP Semiconductors be liable for any indirect, incidental, punitive, special or consequential damages (including - without limitation - lost profits, lost savings, business interruption, costs related to the removal or replacement of any products or rework charges) whether or not such damages are based on tort (including negligence), warranty, breach of contract or any other legal theory.

Notwithstanding any damages that customer might incur for any reason whatsoever, NXP Semiconductors' aggregate and cumulative liability towards customer for the products described herein shall be limited in accordance with the Terms and conditions of commercial sale of NXP Semiconductors.

Right to make changes - NXP Semiconductors reserves the right to make changes to information published in this document, including without limitation specifications and product descriptions, at any time and without notice. This document supersedes and replaces all information supplied prior to the publication hereof.

Suitability for use - NXP Semiconductors products are not designed, authorized or warranted to be suitable for use in life support, life-critical or safety-critical systems or equipment, nor in applications where failure or

malfunction of an NXP Semiconductors product can reasonably be expected to result in personal injury, death or severe property or environmental damage. NXP Semiconductors accepts no liability for inclusion and/or use of NXP Semiconductors products in such equipment or applications and therefore such inclusion and/or use is at the customer's own risk.

Applications — Applications that are described herein for any of these products are for illustrative purposes only. NXP Semiconductors makes no representation or warranty that such applications will be suitable for the specified use without further testing or modification.

Customers are responsible for the design and operation of their applications and products using NXP Semiconductors products, and NXP Semiconductors accepts no liability for any assistance with applications or customer product design. It is customer's sole responsibility to determine whether the NXP Semiconductors product is suitable and fit for the customer's applications and products planned, as well as for the planned application and use of customer's third party customer(s). Customers should provide appropriate design and operating safeguards to minimize the risks associated with their applications and products.

NXP Semiconductors does not accept any liability related to any default, damage, costs or problem which is based on any weakness or default in the customer's applications or products, or the application or use by customer's third party customer(s). Customer is responsible for doing all necessary testing for the customer's applications and products using NXP Semiconductors products in order to avoid a default of the applications and the products or of the application or use by customer's third party customer(s). NXP does not accept any liability in this respect.

Limiting values — Stress above one or more limiting values (as defined in the Absolute Maximum Ratings System of IEC 60134) will cause permanent damage to the device. Limiting values are stress ratings only and (proper) operation of the device at these or any other conditions above those given in the Recommended operating conditions section (if present) or the Characteristics sections of this document is not warranted. Constant or repeated exposure to limiting values will permanently and irreversibly affect the quality and reliability of the device.

Terms and conditions of commercial sale - NXP Semiconductors products are sold subject to the general terms and conditions of commercial sale, as published at http://www.nxp.com/profile/terms, unless otherwise agreed in a valid written individual agreement. In case an individual agreement is concluded only the terms and conditions of the respective agreement shall apply. NXP Semiconductors hereby expressly objects to applying the customer's general terms and conditions with regard to the purchase of NXP Semiconductors products by customer.

No offer to sell or license - Nothing in this document may be interpreted or construed as an offer to sell products that is open for acceptance or the grant, conveyance or implication of any license under any copyrights, patents or other industrial or intellectual property rights.

Export control - This document as well as the item(s) described herein may be subject to export control regulations. Export might require a prior authorization from competent authorities.

74CBTLVD3861 Product data sheet

#### 10-bit level-shifting bus switch with output enable

**Non-automotive qualified products** — Unless this data sheet expressly states that this specific NXP Semiconductors product is automotive qualified, the product is not suitable for automotive use. It is neither qualified nor tested in accordance with automotive testing or application requirements. NXP Semiconductors accepts no liability for inclusion and/or use of non-automotive qualified products in automotive equipment or applications.

In the event that customer uses the product for design-in and use in automotive applications to automotive specifications and standards, customer (a) shall use the product without NXP Semiconductors' warranty of the product for such automotive applications, use and specifications, and (b) whenever customer uses the product for automotive applications beyond

### **15. Contact information**

NXP Semiconductors' specifications such use shall be solely at customer's own risk, and (c) customer fully indemnifies NXP Semiconductors for any liability, damages or failed product claims resulting from customer design and use of the product for automotive applications beyond NXP Semiconductors' standard warranty and NXP Semiconductors' product specifications.

### 14.4 Trademarks

Notice: All referenced brands, product names, service names and trademarks are the property of their respective owners.

For more information, please visit: http://www.nxp.com

For sales office addresses, please send an email to: <a href="mailto:salesaddresses@nxp.com">salesaddresses@nxp.com</a>

10-bit level-shifting bus switch with output enable

### 16. Contents

1	General description 1
2	Features and benefits 1
3	Ordering information 2
4	Functional diagram 2
5	Pinning information 3
5.1	Pinning 3
5.2	Pin description 4
6	Functional description 4
7	Limiting values 4
8	Recommended operating conditions 5
9	Static characteristics 5
9.1	Test circuits 6
9.2	Typical pass voltage graphs 6
9.3	ON resistance 8
9.4	ON resistance test circuit 8
10	Dynamic characteristics 9
10.1	Waveforms
10.2	Additional dynamic characteristics 12
10.3	Test circuit
11	Package outline 13
12	Abbreviations 16
13	Revision history 16
14	Legal information 17
14.1	Data sheet status 17
14.2	Definitions 17
14.3	Disclaimers
14.4	Trademarks 18
15	Contact information 18
16	Contents

Please be aware that important notices concerning this document and the product(s) described herein, have been included in section 'Legal information'.

© NXP B.V. 2011.

All rights reserved.

For more information, please visit: http://www.nxp.com For sales office addresses, please send an email to: salesaddresses@nxp.com

Date of release: 14 December 2011 Document identifier: 74CBTLVD3861